



Click [here](#) for the 3D model.

General Information

| | |
|----------------|------------------------------|
| Series | MPGV |
| Style | SMD Molded |
| Core | Metal Composite |
| Description | Surface Mount Inductor |
| Features | Power Inductors |
| RoHS | Yes |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Miscellaneous | 40 (K) Temperature Rise Max. |

Dimensions

| | |
|-----------|-----------------|
| Chip Size | 1054 |
| L | 10.8mm +/-0.3mm |
| W | 10mm +/-0.2mm |
| T | 5.4mm MAX |
| G | 4.7mm +/-0.3mm |

Packaging Specifications

| | |
|--------------------------|------------|
| Typical Component Weight | 3 g |
| Packaging | T&R, 330mm |
| Packaging Quantity | 500 |

Specifications

| | |
|-------------------------|---|
| Inductance | 15 uH (0.1 MHz) |
| Inductance Tolerance | 20% |
| Inductance | 15 uH |
| Rated Current | 6.6 A (Irms, 40C Rise By Self Heating) |
| Saturation Current | 7 A (Isat, 20% Drop In Inductance), 11 A (Isat, 30% Drop In Inductance) |
| Temperature Range | -55/+155°C |
| Shielded | Yes |
| Current | 6.6 A (Irms, 40C Rise By Self Heating), 7 A (Isat, 20% Drop In Inductance), 11 A (Isat, 30% Drop In Inductance) |
| DC Resistance | 34.2 mOhms |
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| Self-Resonant Frequency | 7.5 MHz |

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